APPLICA	BLE STANI	DARD										
Operating Temperature Ra		ange	-40 °C to 140 °C (1)			torage emperature Range			-10 °C to (
Rating	Voltage		125 V AC ⁽³⁾		Sto	orage Hui	lumidity Range Relative humidity 6 (Not dewed		% max			
Current		0.5 A			perating H	Humidity Range Relative humidity 85% max (Not dewed)						
			SPEC	IFIC/	1OITA	IS						
IT	EM		TEST METHOD				REG	QUII	REMENTS	QT	AT	
CONSTRI					1						1	
General Examination		Examined visually and with a measuring instrument.								×	×	
Marking		Confirmed visually.				Accordin	ng to the	drawi	ng.	×	×	
ELECTRIC	CAL CHARA	CTERIS	STICS		ı.					1	l .	
Contact Resistance		Measured at 100 mA MAX.(DC or 1000Hz) 65mΩ MAX.								×	_	
Insulation Resistance		Measured at 250 V DC.				1000 MΩMIN.				×	_	
Voltage Proof		375 V AC applied for 1 min.				No flashover or breakdown.				×	_	
MECHANI	CAL CHAR	ACTER	ISTICS								•	
Mating and Unmating Forces		Measured with an applicable connector.			Mating Force: 30 N MAX. Unmating Force: 3.3 N MIN.				×	-		
Mechanical Operation		Mated and unmated 10 times.				①Contact Resistance : 75mΩ MAX.				×	† -	
Vibration		Frequency 50~100 → 100~150 → 150~300Hz				②No damage, cracks or looseness of parts. ①No electrical discontinuity of more than 1 μs.				×	+_	
Visitation		Acceleration 98 \rightarrow 98~294 \rightarrow 294 m/s ² 1 cycle 3 min			②No damage, cracks or looseness of parts.							
Shock		3 h for 3 axial directions ⁽⁴⁾ Acceleration 980 m/s ² , duration of pulse 6 ms								×	+-	
<u> </u>			s for 3 axial directions.									
	MENTAL C		TERISTICS						== 0			
Damp Heat (Steady state)		Exposed at 60±2 °C, 90 ~ 95 %, 1000 h.				①Contact Resistance : $75m\Omega$ MAX. ②Insulation Resistance : $1000 \text{ M}\Omega$ MIN.				×	_	
Rapid Change of		Temperature -40 → +140 °C				③No damage, cracks or looseness of parts.				×	+	
Temperature		Time $30 \rightarrow 30$ min.				©140 do	iiiago, oi	uono	or recognices of parts.	^		
		under 1000 cycles. (Relocation time to chamber : within 2~3 MIN)										
Cold		Exposed at -40°C, 1000 h				①Contact Resistance: 75mΩ MAX.				×	_	
Dry Heat		Exposed at 140°C, 1000 h				②No damage, cracks or looseness of parts.				×	_	
Sulfur Dioxide		Exposed at 40±2°C, 80±5%RH, 25±5ppm 2 2				Contact Resistance : 75m Ω MAX.				×	_	
Resistance to		1)Reflow	soldering:		Ì	No deformation of case of excessive looseness				×	-	
Soldering Heat		Peak TMP: 260°CMAX Reflow TMP: 220°CMIN for 60sec				of the terminal.						
		<u> </u>										
Solderability		Soldered at solder temperature 240±3°C for immersion duration, 3 sec.			A new uniform coating of solder shall cover a minimum of 95 % of the surface being immersed.				×	_		
							,					
				1								
			SCRIPTION OF REVISIONS DESI			GNED CHECKED				DA	TE	
<u>/</u> 3\ 1					ABE			HH. SHINDO	2022121			
		erature rise caused by current-carrying.			APPROVED		VED	HH. SHINDO	2019	90809		
(-	before assem	neans a long-term storage state for the unused produc bly to PCB.				CHECKED		ŒD	KN. SHIBUYA	2019	90809	
(3)	The creepage	distance conforms to IEC 60664-1.			DESIGNED		NED	KT. DOI	20190809			
	Voltage effect	ctive value: 32V AC, Pollution Degree: 2			DD AVAAL		/N	KI. YAMAZAKI	20190809			
			ector mounting part and PCB is 0.05mm MA urance Test X:Applicable Test			PRAWING NO.			ELC-376642-00-00			
			···						FX26-30S-1SV15			
 		COS SI SOTRIO COLLET								/3\	1/1	
		OSE ELECTRIC CO., LTD. CC			CODE	DE NO. CL05		U5/	76-1203-0-00 📗 🗸		1/ 1	